UNITED STATES SECURITIES AND EXCHANGE COMMISSION WASHINGTON, DC 20549

FORM 8-K CURRENT REPORT

Pursuant to Section 13 or 15(d) of the **Securities Exchange Act of 1934**

November 15, 2006 Date of report (Date of earliest event reported)

TTM TECHNOLOGIES, INC.

(Exact Name of Registrant as Specified in Charter)

DELAWARE

(State or other jurisdiction of incorporation)

0-31285

(Commission File Number)

91-1033443

(IRS Employer Identification Number)

2630 SOUTH HARBOR BOULEVARD SANTA ANA, CALIFORNIA 92704

(Address of Principal Executive Offices) (Zip Code)

(714) 327-3000

(Registrant's telephone number, including area code)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions (see General Instruction A.2. below):

Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)

Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)

Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))

Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c))

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Item 7.01. Regulation FD Disclosure. Item 9.01. Financial Statements and Exhibits SIGNATURE EXHIBIT INDEX EX-99.1

Item 7.01. Regulation FD Disclosure.

The Company is furnishing this Report on Form 8-K pursuant to Regulation FD in connection with the disclosure of textual information from a slide show presentation given at the UBS Global Communications and Technology Conference on November 15, 2006.

The information in this Report on Form 8-K (including the exhibit) is furnished pursuant to Item 7.01 and shall not be deemed to be "filed" for the purpose of Section 18 of the Securities Exchange Act of 1934 or otherwise subject to the liabilities of that section. This Report will not be deemed an admission as to the materiality of any information in the report that is required to be disclosed solely by Regulation FD.

The Company does not have, and expressly disclaims, any obligation to release publicly any updates or any changes in the Company's expectations or any change in events, conditions, or circumstances on which any forward-looking statement is based.

The information included with this Report includes graphic images or slides used in the presentation. These slides will also be available for viewing at our website located at <u>www.ttmtech.com</u>, although we reserve the right to discontinue that availability at any time.

The information in this Report includes references to "EBITDA." EBITDA means earnings before interest expense, income taxes, depreciation and amortization. We present EBITDA to enhance the understanding of our operating results. EBITDA is a key measure we use to evaluate our operations. In addition, we provide our EBITDA because we believe that investors and securities analysts will find EBITDA to be a useful measure for evaluating our operating performance and comparing our operating performance with that of similar companies that have different capital structures and for evaluating our ability to meet our future debt service, capital expenditures and working capital requirements. However, EBITDA should not be considered as an alternative to cash flows from operating activities as a measure of liquidity or as an alternative to net income as a measure of operating results in accordance with accounting principles generally accepted in the United States.

Item 9.01. Financial Statements and Exhibits

(a) Financial Statements of Business Acquired.

Not applicable.

(b) Pro Forma Financial Information.

Not applicable.

(c) Exhibits.

Exhibit 99.1. Slides presented at the UBS Global Communications and Technology Conference on November 15, 2006.

SIGNATURE

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

TTM TECHNOLOGIES, INC.

Date: November 15, 2006

By: /s/ Steven W. Richards Steven W. Richards Chief Financial Officer

EXHIBIT INDEX

99.1 Slides presented at the UBS Global Communications and Technology Conference on November 15, 2006.

TTM Technologies, Inc.

Investor Presentation UBS Global Communications & Technology Conference Wednesday, November 15, 2006



TTM and Industry Overview

Kent Alder - President and Chief Executive Officer, TTM

This presentation contains forward-looking statements that relate to future events or performance. These statements reflect the company's current expectations, and the company does not undertake to update or revise these forward-looking statements, even if experience or future changes make it clear that any projected results expressed or implied in this or other company statements will not be realized. Furthermore, readers are cautioned that these statements involve risks and uncertainties, many of which are beyond the company's control, which could cause actual results to differ materially from the floward-looking statements. These risks and uncertainties include, but are not limited to, the company's dependence upon the electronics industry, the company's dependence upon a small number of customers, general economic conditions and specific conditions in the markets TTM addresses, the unpredictability of and potential fluctuation in future revenues and operating results, increased competition from low cost foreign manufacturers, and other "Risk Factors" set forth in the company's most recent SEC filings.

Company History

Incorporated in 1978, TTM has a proven track record of executing successful transactions, including debt and equity capital raises and acquisitions

• The Company has successfully operated as a leveraged entity

recapitali Capital /	l leveraged zation with Brockway M 1\$63 millior	loran.	December 1 Changed nau TTM Techno	ne to	December 20 Acquired Hon / ACI for \$1.00	eywell C n o	omplete nillion se	eer 2003 ed \$151.8 condlary in d. \$1.7m y)	Acqui \$225,	oer 2006 red Tyco PCG 3 million. Tran ∞d with \$200 vt	saction
1978 March 1978 Incorporated as Pacific Circuits	\$98 million finan œd v pro form a	1999 Power Circo n. Transacti vith debt, re leverage of 7× LTM EBI	uits, for on sulting in f\$133	2001 September 2 Executed IPC NASDAQ, ra \$120 million i proceeds)on Comp ising secor	200 Jary 2002 Jeted \$53 Idary offer Imm of priv	.6 millior ing (ind	n Ó	2005 March 2005 Completed exp Chippewa Falls		2007
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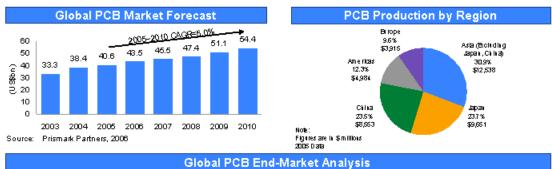
- Largest North American PCB
- Strategically focused
- Time Technology Mix Military Aerospace
- Specialized facilities
- Diversified customer base



PCB Market Overview

The \$40 billion global PCB market is projected to grow at 6% through 2010

The \$4.5 billion North American PCB segment represents approximately 10% of the global market



End-Market Growth 2005-2010E CAGR

Auto	3.2%
Communications	<mark>6.7%</mark>
Computing	4.9%
Consumer	4.6%
Industrial/Medical	4.0%
Military	<mark>6.1%</mark>
Packaging	11.1%
Total	6.0%

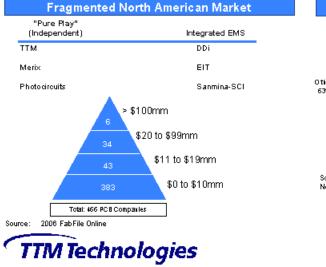
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North American PCB Market Overview

The \$4.5 billion North American PCB market is highly fragmented

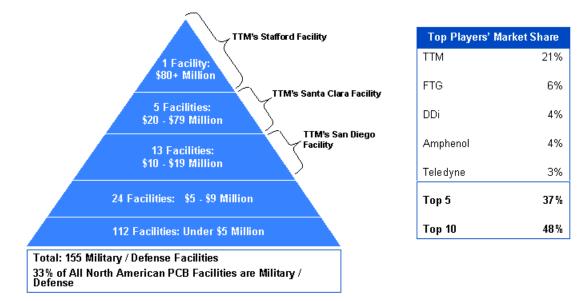
- TTM now holds the #1 market share position in North America
- Larger, well-capitalized players with focused strategies, significant scale and advanced technology capability are positioned to benefit from on-going industry consolidation
- North American industry capacity has declined significantly since 2000
 - Total number of PCB manufacturers reduced by approximately 50%
 - Only 6 companies have over \$100 million in sales





U.S. Military / Defense PCB Market

TTM is the clear leader in the fragmented U.S. defense market



Source: Facility data from Harvey Miller FabFile, 2006 and Company estimates. Total market size from Henderson Ventures

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PCB Industry Trends

frend	Implications				
Decreasing electronic	 Ongoing technology advances have shortened product life cycles, placing increasing pressur on OEMs to increase time-to-market speed 				
product life cycles	 PCB suppliers with leading quick-turn capabilities stand to benefit 				
	 Higher performance products require increasingly complex PCBs that can accommodate higher speeds and component densities 				
Increasing complexity of electronic	 Complex PCBs require high layer counts, advanced manufacturing processes and high- mix production capabilities 				
products	 OEMs increasingly rely on larger PCB suppliers that have the resources needed to invest in and develop advanced manufacturing process technologies and engineering staff 				
	 Significant migration of electronics manufacturing to Asia to capitalize on low-cost labor 				
	 Primarily in consumer electronics products that utilize commodity-type PCBs with lower layer counts and complexity 				
Migration of commodity PCB manufacturing	 Migration is largely complete and North American market has stabilized 				
to Asia	 PCBs requiring complex technologies, high layer-counts, quick turnaround times and advanced manufacturing processes subject to limited foreign competition 				
	 Military applications not subject to Asian competition due to Department of Defense approval requirements 				
Decreased reliance	OEMs are increasingly rationalizing PCB supplier base to cut costs and improve efficiencies				
Decreased reliance on multiple PCB Suppliers by OEMs	 Increasing dependence on larger suppliers that can offer one-stop manufacturing capabilities from prototype through volume production 				

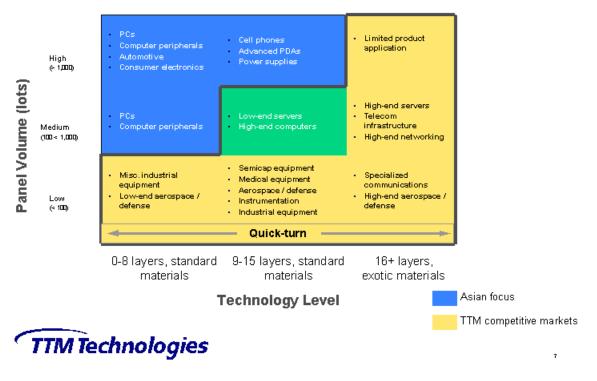
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TTM is well-positioned to capitalize on major PCB industry trends

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PCB Competitive Landscape

Advanced technology, quick-turn and military segments are well-protected in North America



Company Overview - TTM

Kent Alder - President and Chief Executive Officer, TTM

Competitive Strengths

 Time-critical and highly complex manufacturing services through advanced technology expertise Leading quick-turn platform provides critical services for new product introduction across diverse end-markets
 Products / services support all stages of an electronic product's life cycle – from prototype through volume production Focused facility specialization strategy – speed, flexibility, technology
 Difficult business model to replicate Significant technology expertise, employee training and investment required Limited threat from Asian competition in quick-turn, high layer-count and defense markets
 Strong relationships with leading OEM and EMS customers Significant active customers across telecom, computing, industrial and military markets Long-standing relationships with top customers
 Profitable business model across cycle Superior margins / operating metrics to competition Strong, consistent cash flow generation, even during protracted downturn from 2001-02
 Seasoned management team led by CEO with 26 years of industry experience Focused strategy has provided growth / stability across cycle Proven ability to integrate acquisitions
 Moderate pro forma credit profile – total leverage of approximately 2.3× LTM 7/3/06 Adjusted EBITDA Strong asset coverage Minimal near-term maturities – limited debt service requirements Strong liquidity – approximately \$110.6 million of cash and availability under new Revolver

TTM's Strategy

	Military / Aerospace #1 North America Supplier Rigid Flex and speciality P.C.B. products Backplane and sub Assembly 	
Technology • High performance, technologically complex PCBs • Advanced manufacturing processes & technology expertise • Industry-leading average layer count of 20+ at Chippewa Falls facility	Industry-Leading Execution and Financial Results Strong Long-Term Outlook	Time Dedicated ultra-short lead time capability (<24 hours available) Dedicated, highly flexible, ramp-to- volume production in <10 days High-mix complex technology production with standard delivery
TTM Technologie	Financial Strength Focus on operational excellence Superior asset management and strong balance sheet Successful integration of opportunistic acquisitions	

Key Customers by End Market

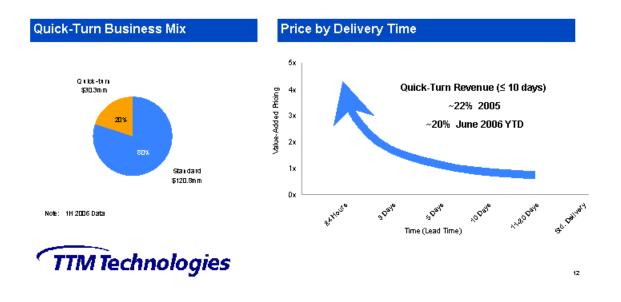
	1H06 Sales	Selected Key Customers	Selected Applications
Networking / Communications	44%	CISCO SYSTEMS MOTOROLA FORCE CO SIEMENS SIEMENS	 Enterprise routers Semiconductor and switches Wireless base stations and cell Fiber optic transponders
Computing / Storage / Peripherals	32%	Sgi SMART Model Technologie Sgi UNISYS Imagine it. Done.	 Mainframes, servers Semiconductor technology across all end markets DRAM and FLASH memory products Workstations targeted to OEM's
Medical / Industrial Instrumentation / Other	12%	Agilent Technologies	 Industrial controls and Vision instruments for power generation systems Portable uttrasound Insulin delivery systems
Military / Aerospace	12%		 Thermal weapons sight (infrared scopes) Rugged, secure radios for military applications Secure phones for military, police and government In flight entertainment systems
TTM Techn	ologi	ies	,

TTM serves over 585 active customers across a broad range of end-markets

Industry-Leading Quick-Turn Capability

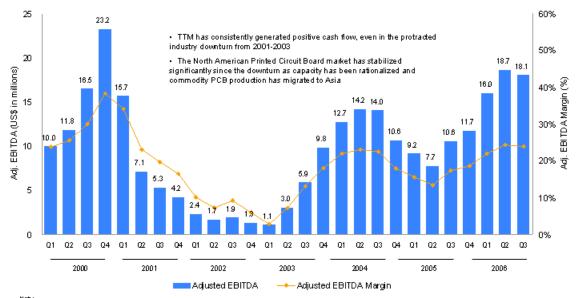
TTM's leading quick-turn platform generates premium pricing, while serving as a platform to attract new customers

- Dedicated ultra-short lead-time capability (< 24 hours available)
- Dedicated, highly flexible, ramp-to-volume production in < 10 days



Quarterly Adjusted EBITDA

Strong Adjusted EBITDA margins facilitate consistent generation of positive free cash flow

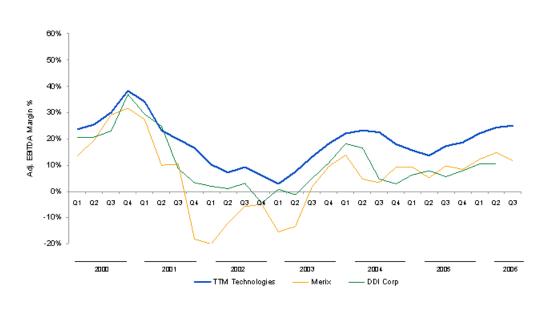


Note: 1 EBITDA hip holio fillings differs from Adjusted EBITDA above due to extraordinary galus, interest income and other, restructuring charges, loss contingency accurationarge, and stock taxed compensation expense

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EBITDA Margin Benchmarking

Relative to its peers, TTM has been more effective at managing through PCB business cycles



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Company Overviews – former Tyco PCG

Doug Soder - Executive Vice President

Former Tyco PCG

Business Overview

- Provider of complex, high performance printed circuit boards
 - $\$ #1 supplier of military and aerospace PCB's in North America
 - $\,$ Rigid, flexible, rigid-flex and specialty PCB's $\,$
- PCB-related services include initial concept design, product simulation, prototyping and quick-turn assembly
- Tyco PCG also offers backplane and sub-system assembly services for both standard and specialty products
- Founded in 1964 and headquartered in Enfield, CT
- Acquired by Tyco in 1967
- Operates 8 manufacturing facilities in North America and 1 in China
 - 3 commercial PCB facilities
 - 3 military PCB facilities
 - 3 assembly facilities
- LTM 6/30/06 revenues and Adjusted EBITDA of \$379.4 million and \$29.2 million, respectively





Competitive Strengths

#1 PCB supplier to the US defense industry	 Recognized for over four decades as the leading supplier to the US defense and aerospace industry Market share within military / aerospace segment is approximately twice that of its nearest competitor Significant barriers to entry in the North America defense market
Extensive materials and manufacturing process expertise	 Engineering, materials and process expertise are among the most technically advanced in the PCB industry Tyco PCG's advanced materials offer electrical, thermal and reliability advantages over conventional materials Currently the leading producer of large format multi-layer, Radio Frequency ("RF") PCB products
Collaborative partnerships with customer R&D teams	 Early access gained to volume production sales opportunities because of customer trust and cooperation In 2005, Tyco PCG was awarded 85 new design wins
Long-term customer relationships with industry leaders	 Long-standing customer relationships (many in excess of 20 years) Reputation of providing high quality products and capabilities to leading OEMs
China presence	 Assembly facility in Shanghai offers customers low cost manufacturing alternative Facility may also serve as a platform from which to expand PCB operations into China
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Former Tyco PCG Facilities

Overview of Tyco PCG

Segment	Pacili tie 🛛	Sum m ary
Military PCB	 Stafford, CT Santa Dara, CA San Diego, CA 	 Oustom defense PCB products include multi-layer PCBs, ngid-flex, thermal management PCBs, RF PCBs and backpanels Produceshigh reliability PCBs for demanding and technically sphisicated applications including the F22 Raptor and F36 Joint 3 the Fighter
Commercial PCB	 Dallas, OR Los Angeles, CA Logan, UT 	 Manufacturer of multi-layer printed circuit boards and backpanels for leading companies in the following markets: Telecom/Networking Medical Industrial/Test/ Instrumentation Computing Storage/ Peripherals Provides full range of services from quick turn delivery to prototype and volume production
Assembly/ Systems Integration	 Stafford Springs, CT Hayward, CA Shanghai, China 	 Full service provider of highly complex backplane and midplane assemblies, electro- mechanical assemblies, system design, system integration and thermal management

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Facility Footprint



Tyco Printed Circuit Group:

Military PCB: • Stafford, CT	Commercial PCB:	Assembly: Stafford Springs, CT
🕙 Santa Clara, CA	📀 Los Angeles, CA	🚯 Hayward, CA
San Diego, CA	🐵 Logan, UT	😰 Shanghai, China

Long-Term Customer Relationships with Industry Leaders

Former Tyco PCG maintains deep, long-term customer relationships with minimal concentration

No customer accounted for more than 8% of 1H 2006 revenues

Customer	% H1 2006 Revenues	Customer Relationship (Years)	Industry Sector
Raytheon	7.7	20+	Defense / Aerospace
and the second s	5.7	30+	Defense / Aerospace
Honeywell	5.4	15+	Defense / Aerospace
😋 Colix	5.3	7+	Telecom / Networking
τu <u>r),</u>	4.7	7+	Telecom / Networking
Hamilton Speaktrand Mitting stops	4.6	20+	Defense / Aerospace
MOTOROLA	3.7	20+	Telecom / Networking
BAE SYSTEMS	3.7	20+	Defense
<u></u>	3.3	5+	Telecom / Networking
NOKIA	2.1	9+	Telecom / Networking
Total	46.2		

Average Top 10 Customer relationship: 15+ years



Combined Company Overview

Kent Alder - President and Chief Executive Officer

Acquisition Rationale

Leading North American PCB player with defensible market positions	 Combines two leading North American PCB players TTM is the leader in time and technology Former Tyco PCG is the leader in military / aerospace Synergy opportunities (personnel, materials) Improved operations with PCB focus 	
Diversification	 Former Tyco PCG's leadership position is the premier platform to enter / consolidate the military / aerospace market Defensible and growing market in North America – isolated from foreign / low cost competition Consistent with TTM's facility specialization strategy Entrée into China via former Tyco PCG's Shanghai facility 	-
Significant financial scale	 Transformational acquisition that doubles TTM's financial metrics Pro forma scale increases strategic options Ability to enhance margins through operating efficiencies 	
TTM Technol	ogies	1

Pro Forma End-Market Analysis

The acquisition more than doubles TTM's exposure to the defense end-market and significantly diversifies its overall revenue base

	TTM	Тусо РСС	Pro Forma
Networking / Communications	44%	45%	44%
Computing / Storage / Peripherals	32%	7%	18%
Medical / Industrial Instrumentation / Other	12%	14%	13%
Military / Aerospace	12%	34%	25%

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Note: 1H 2006 End Market Data

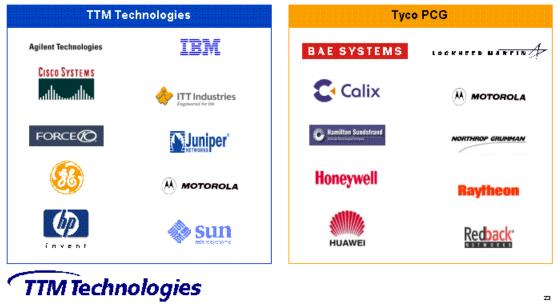
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Pro Forma Customer Analysis

The acquisition reduces TTM's customer concentration, as limited overlap exists between both companies' customers

- PF Top 5 customer concentration in 1H06 declines from 47% to 23% as a result of the acquisition
- PF Top 10 customer concentration in 1H06 declines from 56% to 38%

Top 10 OEM Customers



Pro Forma Customer Concentration

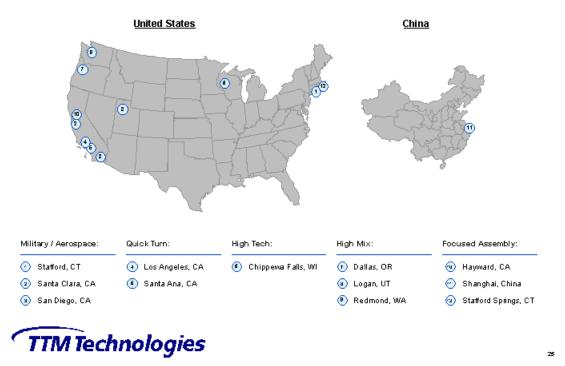
(US\$ in thousan	ids)							
Top 5	TTM Custom	ers	-	co PCG Custom	ers		o Forma Sustomer	s
Creeko Avere u s Carllecto allas de	\$30,774	(20.4%)	Baytheon	\$15,863	(7.7%)	Lista Storeus Arthuaithea	\$30,774	(8.6%)
IBM	14,353	(9.5%)	Sand Printer Construction	11,634	(5.7%)	Raytheon	15,863	(4.4%)
	10,138	(6.7%)	Honeywell	11,049	(5.4%)	IBM	14,353	(4.0%)
	10,124	(6.7%)	😋 Calix	10,887	(5.3%)	Construction on the second second	11,634	(3.3%)
Antipation and the second seco	6,185	(4.1%)	Tur)n	9,684	(4.7%)	Honeywell	11,049	(3.1%)
Top 5 Customer Sales	\$71,574	(47.3%)		\$59,117	(28.8%)		\$83,675	(23.4%)
Total Sales	\$151,165	(100.0%)		\$205,539	(100.0%)		\$356,704	(100.0%)
Note: Figures are (gross sales for	1H 2006						

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Combined Facility Footprint

The pro forma footprint enables TTM to continue to execute its facility specialization strategy



Summary

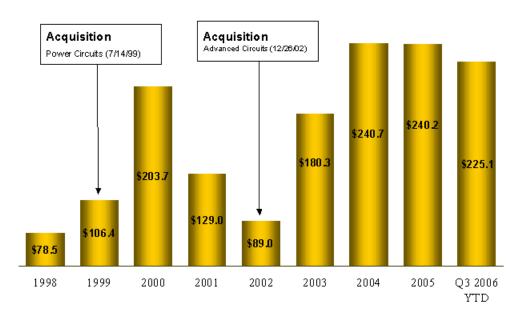
Leading market position in most attractive PCB segments	 Leading market positions in advanced technology / high layer-count, quick-turn, and military segments Limited competition with high barriers to entry Focused strategy has provided growth and stability across cycle
Diversified revenue base	 Acquisition results in significantly more diversified pro forma company Balanced end-market exposure Leading OEM customers with minimal revenue concentration
Largest player in North America with significant size and scale	 #1 market share position in highly fragmented North American market Competitive advantage given improved purchasing leverage, customer credentials, and internal growth potential from resource sharing
Industry-leading financial performance	 Superior margins/operating metrics to competition Strong, consistent cash flow generation Strong balance sheet
Experienced management team with proven execution track record	 Seasoned management team lead by CEO with 26 years of industry experience Strong, long-term customer and supplier relationships Proven ability to integrate acquisitions



Historical Financials – TTM Technologies

Steve Richards - Chief Financial Officer, TTM

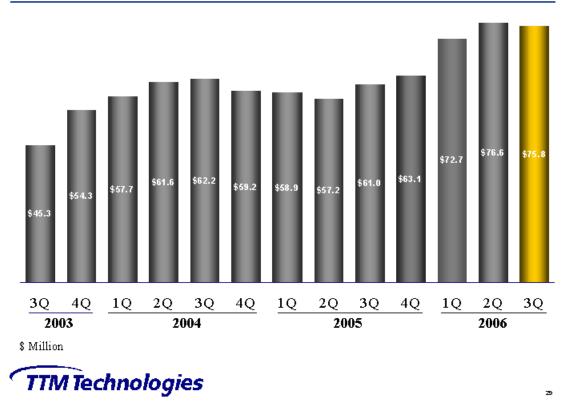
Annual Sales



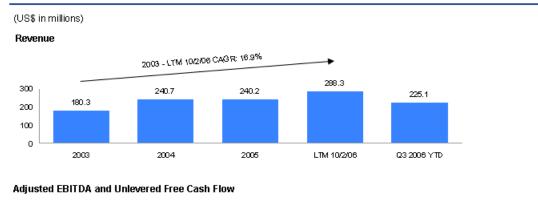
\$ Millions

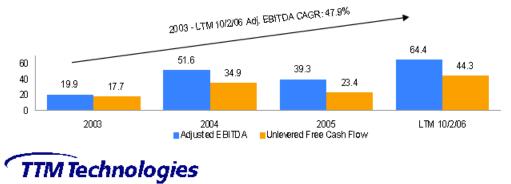


Quarterly Sales



Historical Revenue, Adjusted EBITDA and Unlevered Free Cash Flow





Quarterly Results And Estimates

		20	05					2006	
	1Q	2Q	3Q	4Q	•	1Q	2Q	3Q	4QE
Sales	\$58.9	\$57.2	\$61.0	\$63.1		\$72.7	\$76.6	\$75.8	\$140.0 - \$148.0
Gross Profit	13.5	11.0	14.2	15.0		20.2	22.9	22.5	26.0 - 30.0
% Margin	23%	19%	23%	24%		28%	30%	30%	18% - 20%
Operating Income	6.8	4.8	5.9	8.8		13.0	15.6	15	10.0 - 14.0
GAAP Diluted EPS	\$0.11	\$0.08	\$0.10	\$0.46		\$0.21	\$0.25	\$0.25	\$0.13 - \$0.19

\$ Millions, except per share data

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Historical Income Statement

(US\$ in millions)	Fiscal Year			
· · ·	2003	2004	2005	LTM 10/2/00
Revenue	\$180.3	\$240.7	\$240.2	\$288.3
Cost of Goods Sold	145.7	172.1	186.5	207.6
GrossProfit	34.6	68.5	53.8	80.7
Selling and Marketing Expense	10.9	12.0	12.0	13.2
General and Administrative Expenses	11.7	13.2	11.9	13.9
Loss Contingency Accrual	0.0	0.0	2.2	0.0
Amortization of Intangibles	1.2	1.2	1.2	1.2
Restructuring Charges	0.6	0.9	0.0	0.0
Operating Income	10.2	41.2	26.4	52.4
Interest Expense	0.6	0.4	0.2	0.1
Amortization of Debt Issuance Costs	0.1	0.1	0.1	0.1
Interest (Income) and Other	(0.4)	(0.8)	(2.1)	(4.2)
Income Before Taxes	9.9	41.5	28.3	56.4
Tax Provision (Benefit)	3.9	13.2	(2.5)	7.4
Income Before Extraordinary Items	6.0	28.3	30.8	48.9
Extraordinary Gain	1.5	0.0	0.0	0.0
NetIncome	\$7.4	\$28.3	\$30.8	\$48.9
Growth and Margins				
Revenue Growth	102.6%	33.5%	(0.2%)	-
Gross Margin	19.2%	28.5%	22.4%	28.0%
Operating Income Margin	5.7%	17.1%	11.0%	18.2%
Adjusted EBITDA Margin	11.0%	21.5%	16.3%	22.4%
Net Income Margin	4.1%	11.8%	12.8%	17.0%

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Historical Balance Sheet

\$ Millions	12/31/2005	10/2/2006
Cash and short-term investments	\$82.4	\$110.3
Accounts receivable, net	\$38.6	\$45.2
Inventories, net	\$12.6	\$14.9
Net property, plant and equipment	\$51.8	\$53.0
Other assets	\$87.7	\$85.6
Total assets	\$273.1	\$309.0
Accounts payable	\$11.3	\$13.7
Other current liabilities	\$16.7	\$14.5
Long-term liabilities	\$1.1	\$0.0
Stockholders' equity	\$244.0	\$280.8
Total liabilities and stockholders' equity	\$273.1	\$309.0
TTM Technologies		72

Historical Revenue, Adjusted EBITDA and Unlevered Free Cash Flow

(US\$ in millions)	Fiscal Year			
	2003	2004	2005	LTM 10/2/06
Revenue	\$180.3	\$240.7	\$240.2	\$288.3
Adjusted EBITDA	19.9	51.6	39.3	64.4
Plus: Changes in Working Capital	(1.3)	0.9	(4.8)	7.0
Less: Capital Expenditures	6.6	17.5	8.0	10.5
Less: Cash Taxes	(5.7)	0.2	3.1	16.6
Unlevered Free Cash Flow	\$17.7	\$34.9	\$23.4	\$44.3
Adjusted EBITDA Margin	11.0%	21.5%	16.3%	22.4%
Unlevered Free Cash Flow Margin	9.8%	14.5%	9.8%	15.4%
Unlevered Free Cash Flow Conversion (1)	89.1%	67.5%	59.7%	68.8%

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Note:

(1) Unlevered Free Cash Flow / Adjusted EBITDA



Historical Financials – Tyco PCG

Steve Richards - Chief Financial Officer, TTM

Historical Summary Financials

Fiscal Year Basis

(US\$ in millions)	FY End	0,	
· · ·	2004	2005	2006
Revenue	\$368.7	\$344.8	\$406.6
Cost of Goods Sold	306.2	300.9	352.4
Gross Profit	62.5	43.8	54.3
Selling Expense	19.1	17.4	19.9
General and Administrative Expenses	20.2	13.2	16.4
Other Expense / (Income)	0.4	0.0	(0.3)
EBIT	22.9	13.2	18.3
Depreciation	15.7	16.1	15.7
Adjusted EBITDA	38.5	29.3	34.0
Capital Expenditures	\$6.8	\$12.9	\$9.9
Growth and Margins			
Revenue Growth	19.6%	(6.5%)	18.0%
Gross Margin	17.0%	12.7%	13.3%
EBIT Margin	6.2%	3.8%	4.5%
Adjusted EBITDA Margin	10.4%	8.5%	8.4%

Source: Unaudited financial statements



Historical Financials – Combined

Steve Richards - Chief Financial Officer, TTM

Historical Financials

(US\$ in millions)	CY Ended De	CY Ended December 31,	
	2004A	2005A	10/2/06A (1)
Revenue:			
TTM	\$240.7	\$240.2	\$288.3
Tyco PCG	366.9	354.3	406.6
Total Revenue	607.5	594.6	694.9
Gross Profit:			
πм	68.5	53.8	80.7
Tyco PCG	59.2	40.7	54.3
Total Gross Profit	127.8	94.5	135.0
Operating Income:			
πм	41.2	26.4	52.4
Tyco PCG	22.0	10.0	18.3
Total Operating Income	63.2	36.4	70.7
Adjusted EBITDA:			
TTM	51.6	39.3	64.4
Tyco PCG	37.7	26.1	34.0
Total Adjusted EBITDA	89.3	65.4	98.5
Growth and Margins			
Revenue Growth	20.6%	(2.1%)	
Gross Margin	21.0%	15.9%	19.4%
Operating Income Margin	10.4%	6.1%	10.2%
Adjusted EBITDA Margin	14.7%	11.0%	14.2%
Cap Ex as a % of Revenue	4.7%	3.0%	2.9%

Source: TTM: audited and interim financial statements; Tyco PCG: unaudited financial statements

Note:

(1) Represents TTM LTM 10/2/06 and PCG LTM 9/30/06



TTM Technologies, Inc.

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